Amendments to the Specification:

Please delete the Sections of the Specification identified below, and replace them with the following substitute Sections:

Please delete the Section entitled "BACKGROUND OF THE INVENTION," and replace it with:

- - 1. Field of the Invention

The invention relates to a method for improving the imaging properties of at least two optical elements. More particularly, the invention relates to such a method in which the relative position of the optical elements is mutually adjusted in order to improve the optical imaging. The invention further relates to a photolithographic fabrication method.

2. Description of Related Art

From EP 1 063 684 A1 it is known to determine the birefringence distribution of individual lenses inside a projection lens of a projection exposure system as a polarisation-dependent perturbation. The lenses are then selected and arranged inside the projection lens so as to obtain a total birefringence whose magnitude is less than a predetermined limit value for each optical path through the projection lens. The total birefringence is in this case made up of the sum of all the birefringences of the individual lenses being analysed. Such a method is helpful when lenses need to be rejected on the basis of an intolerable birefringence distribution, but in practice does not always lead to specification values being achieved for the imaging properties of the optical elements.

Another optimisation method is known from the specialist article "The development of microlithographic high-performance optics", Int. J. of Optoelec., 1989, 545. When optimising the imaging properties of optical systems having optical elements which are made of crystalline materials, this method provides satisfactory results only if the crystalline materials are specially selected and the optical elements are mounted without stress. Such measures are expensive. - -

Please delete the Section entitled "SUMMARY OF THE INVENTION," and replace it with:

- - It is therefore a first object of the present invention to refine an optimisation method of the type mentioned in the introduction, so that a total imaging error made up of the imaging errors of the individual optical components can be further reduced for most practical applications.

This object is achieved by a method comprising the following steps: according to the invention by a method having the features mentioned in Claim 1.

- a) determining for at least one of the at least two optical elements a polarization-dependent perturbation;
- b) determining for at least one of the at least two optical elements a polarization-independent perturbation;
- c) calculating a target position for the at least one movable optical element such that, in the

target position, the total perturbation of the at least two optical elements which is made up of the polarization-dependent perturbations and polarization-independent perturbations of the at least two optical elements, is minimized;

d) moving the at least one movable optical element to the target position calculated in step c).

The method according to the invention is based on the following facts:

As a rule, polarisation polarization-dependent and polarisation polarization-independent perturbations contribute to the total perturbation. Polarisation Polarization dependent perturbations can be subdivided into: intrinsically present polarisation polarization dependent perturbations, such as the intrinsic birefringence, i.e. that which occurs even in a homogeneous and stress-free material; polarisation dependent perturbations occurring because of external effects, such as stress birefringence; and polarisation polarization dependent perturbations occurring because of material inhomogeneities, such as birefringence due to crystal defects, especially due to the formation of domains in the material.

As a rule, previous determination methods for determining the imaging errors of optical elements have been restricted to polarisation polarization-independent perturbations, since it was assumed that conventional optical materials have polarisation polarization dependent perturbations only in exceptional cases. These polarisation polarization dependent perturbations have previously been accommodated without including them in a target-position calculation. This was done, as mentioned above, by material selection or special mounting.

It is known from the Internet publication "Preliminary determination of an intrinsic birefringence in CaF₂" by J. H. Burnett, G. L. Shirley and Z. H. Levine, NIST Gaithersburg MD 20899 USA (posted on 7.5.01), however, that single CaF₂ crystals also have non-stress-induced, i.e. intrinsic birefringence. This applies, for example, to ray propagation in the (110) crystal direction. For ray propagation in the (100) crystal direction and in the (111) crystal direction, however, CaF₂ does not have any intrinsic birefringence. The birefringence that occurs is therefore dependent on the ray direction. It cannot be eliminated either by material selection or by stress-free mounting of an optical element.

Since CaF₂ and other crystalline materials with intrinsic birefringence are being used increasingly as optical materials, particularly in conjunction with UV light sources, the neglect of polarisation polarization dependent perturbations is leading to imaging errors which are not picked up in the known optimisation methods.

Polarisation Polarization dependent perturbations cause light rays with orthogonal polarisation polarization to be imaged at different positions. Polarisation Polarization effects can furthermore cause individual polarisation components to experience different imaging errors.

Although the aforementioned EP 1 063 684 A1 takes into account a polarisation-polarization-dependent perturbation, namely the birefringence, it ignores other perturbations in the scope of optimising the mutual arrangement of the optical components, so that there may some be error contributions to the total imaging error which are avoidable.

According to the invention, both the polarisation polarization dependent perturbations and the polarisation polarization independent perturbations are taken into account in the target-position calculation. In this way, the optical elements can be modelled precisely and fully in respect of their imaging properties.

The A polarisation polarization dependent perturbation including stress birefringence according to Claim 2 takes into account the effect of internal stresses in the optical materials. These internal stresses may, for instance, have been frozen in the material during the production process, or may occur because of the mechanical mounting (frame) of the optical element. Taking the stress birefringence into account improves the optimisation of the imaging properties even for optical elements which do not have any intrinsic stress birefringence.

The at least one optical element, whose polarization-dependent perturbation is determined according in step a), may consist of a crystalline material, and the determination of the polarization-dependent perturbation resulting from stress birefringence may comprise a determination of the position of at least one crystal axis. This Determining the position of at least one crystal axis according to Claim 3 can obviate further measurement of polarisation polarization dependent perturbations in the most favourable case, if there are no other polarisation polarization dependent perturbations, since the

intrinsic birefringence can be calculated following determination of the crystal axis position.

A degree of freedom in movement which is relatively straightforward to achieve, since it does not involve significant intervention in the mounting of the optical element, is the rotatability of the at least one optical element in step d) about its axis of symmetry according to Claim 4.

The effects of displacing a linearly displaceable optical element according to Claim-5 on the imaging properties of the at least two optical elements allow precise predictions, for example by means of optical design programs, which facilitates calculation of the target position.

Centring errors, in particular, can be compensated <u>if the at least one movable optical element is</u>

<u>displaced transversely to an optical axisfor by a displaceable optical element according to Claim 6</u>.

A tiltable movable optical element that is tilted relative to an optical axis according to Claim 7, for example, allows alignment of the crystal axes of the optical element relative to the optical axis of an overall optical system, which includes the at least two optical elements.

While this at least one optical element is supported in a frame, this has Tthe effect of determining the polarisation dependent perturbation according to Claim 8 is that the contributions to the stress birefringence from the frame are also taken into account in the determination of the polarisation dependent perturbation. This increases the precision of the optimisation method.

If It is also an object of the present invention to provide a photolithographic fabrication method with improved optical quality.

This object is achieved according to the invention by a method having the features mentioned in Claim 9. The advantages of the fabrication method derive from the aforementioned advantages of the optimisation method.

projection light is used that has a wavelength smaller than 200 nmAt an exposure wavelength according to Claim 10, many optical materials have polarisation polarization dependent perturbations which affect the imaging properties of optical elements more strongly than, for example, when they are exposed to visible light. The optimisation method according to the invention is therefore very effective with exposure to wavelengths of less than 200 nm. - -

Please delete the Section entitled "DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS," and replace it with:

-- A projection exposure system denoted overall by 1 in Figure 1 is used for transferring a structure from a mask 2 to a wafer (not shown in Figure 1).

A light source 3, for example an F_2 laser with a wavelength of 157 nm, generates a projection light beam 4 for this purpose. It passes first through illumination optics 5 for shaping, and subsequently through the mask 2. A projection lens 6 images the structure present on the mask 2 onto the wafer.

In Figure 1, the projection lens 6 is divided into a part 7, rotatable about the optical axis of the projection lens 6, and a stationary part 8. In practice, there are often a plurality of rotatable parts in the projection lens 6; restriction to only one rotatable part 7, however, will suffice for the purpose of this description.

In Figure 1, a biconvex lens 9 is indicated to exemplify the optical components of the rotatable part 7 and a plane-parallel optical plate 10 is indicated to exemplify the optical components of the stationary part 8. Furthermore, as illustrated by a Cartesian coordinate system 20 in Fig. 1, the lens 9 is displaceable both along the optical axis and transversely to the optical axis of the projection lens 6, and it is also tiltable relative to the optical axis of the projection optics 6 as indicated by a double arrow 21 in Fig. 1. The double arrow 21 here denotes one of two possible and mutually perpendicular tilting movements relative to the optical axis. Other optical elements of the projection lens 6, which are not explicitly represented in Fig. 1, may also have the said degrees of freedom in movement.

A position-sensitive sensor 11 is provided in order to analyse perturbations which affect the imaging properties of the projection lens 6. It is displaceable transversely to the optical axis of the projection lens 6, between a measurement position represented in Figure 1 and a projection exposure position (not shown) withdrawn from the optical path of the projection light beam 4 (cf. double arrow 12 in Fig. 1). The sensor 11 is connected to a computer 14 via a signal line 13.

The lens 9 and the optical plate 10 are made from single crystals of CaF₂, which has a cubic crystal symmetry. For production, these optical elements 9, 10 are cut from crystal blocks and polished.

Such a crystal block 15 for the lens 9 is represented by way of example in Fig. 2. It is oriented such

that (100) crystal planes 16 are perpendicular to the plane of the drawing, so that their section lines constitute lines extending horizontally with the plane of the drawing. The lens 9 is machined from the crystal block 15 so that its element axis EA, i.e. the optical axis of the lens 9, coincides with the (100) crystal direction, which is perpendicular to the (100) crystal plane.

The optical plate 10, which is represented separately in Fig. 3, is also machined from a crystal block with such an orientation. Besides the (100) crystal direction, the (101), (110), (10-1) and (1-10) crystal directions are also represented there as arrows, the negative sign when indexing the crystal direction in this description being equivalent to the designation "upper crosswise" in the drawing. An intrinsic birefringence of the optical plate 10 is schematically represented by four "lobes" 17, the areas of which indicate the magnitude of the intrinsic birefringence for the respective ray direction of a light ray of the projection light beam 4 (cf. Figure 1). The maximum intrinsic birefringence of the optical plate 4 is respectively obtained in the (101), (110), (10-1) and (1-10) crystal directions.

The ray direction of a light ray 18 of the projection light beam 4 is defined by an aperture angle θ and an azimuth angle α . Figure 4 illustrates the position of these two angles: a Cartesian coordinate system of the projection exposure system 1 is shown there, the z axis of which coincides with the optical axis of the projection lens 6. The aperture angle θ is the angle between the light ray 18 and the z axis. The azimuth angle α is the angle between the x axis and the projection of the light ray 18 onto the xy plane.

In the following description, the optical components 9, 10 are oriented so that the (100) crystal direction coincides with the z axis and the projection of the (101) crystal direction onto the xy plane

coincides with the x axis.

Figure 5 shows the intrinsic birefringence (IDB) of the optical plate 10 as a function of the azimuth angle α for the aperture angle $\theta = 45$ degrees. A fourfold symmetry is found, the maxima of the intrinsic birefringence being obtained for light rays whose ray directions coincide with the (101), (10-1) and (1-10) crystal directions (cf. Figure 3), that is to say for light rays with an aperture angle θ of 45 degrees and an azimuth angle α of 0 degrees, 90 degrees, 180 degrees and 270 degrees. The intrinsic birefringence vanishes (cf. Figure 3) at an aperture angle of 0 degrees, i.e. a ray direction along the optical axis of the projection lens 6 in the (100) crystal direction.

As the maximum intrinsic birefringence (ray propagation e.g. in the (110) crystal direction, i.e. θ equal to 45 degrees, α equal to 90 degrees), a value of (11.0 +/- 0.4) nm/cm was measured at a wavelength of 156.1 nm for CaF₂.

At the azimuth angles for which intrinsic birefringence occurs (cf. Figure 5), it decreases continuously with the aperture angle for aperture angles of less than 45 degrees (cf. Figure 3).

Besides these intrinsic contributions to the birefringence, the lens 9 and the optical plate 10 have additional stress birefringence contributions depending on their installation situation in the projection lens 6, which are added to the intrinsic birefringence. Further birefringence contributions may, for example, be due to crystal defects, in particular the formation of domains. There may even be non-intrinsic birefringence contributions in optical materials which do not have any intrinsic birefringence.

A method for improving the imaging properties of the projection lens 6 is carried out as follows:

First, the optical perturbations of all the optical elements of the projection lens 6 are determined individually. Such measurement methods for determining the aforementioned birefringence contributions as an example of polarisationpolarization-dependent perturbations, on the one hand, and polarisationpolarization-independent perturbations, on the other hand, are known to the person skilled in the art. To this end, for example, as indicated by the sensor 11 in Figure 1, a measurement of the overall imaging properties of the projection lens 6 may be carried out in different adjustment states of the projection lens 6.

As an alternative or in addition, the individual optical elements of the projection lens 6 may be analysed independently of one another with the aid of known measurement methods. In this case, care should be taken to simulate the installation situation of the optical elements in the projection lens 6 as precisely as possible during this independent analysis, so as to prevent the installation of the optical elements in the projection exposure system 1 from giving rise to additional perturbation contributions, which impair the optimisation of the imaging properties of the projection lens 6.

The determination of the birefringence contributions may, for example, comprise determination of the position of the crystal axes of the optical elements to be analysed, when crystalline materials are involved.

The measurement results are evaluated by the computer 14. It determines the respective perturbation contributions of the individual optical elements of the projection lens, and assigns these contributions to the individual polarisation-dependent and polarisation-independent

perturbations. The computer 14 subsequently calculates and optimises a target function (merit function). This target function takes in the dependencies of the perturbation contributions of all the optical elements on the degrees of freedom in movement of these optical elements (rotation, inclination, centring).

In the exemplary embodiment which is represented, this calculation is carried out for the optical components 9 and 10.

As was mentioned above, the lens 9 is rotatable relative to the optical plate 10 about the optical axis. For the lens 9 and the optical plate 10, their respective contributions to the polarisation polarization dependent and polarisation polarization independent perturbations are available after the perturbation contributions have been analysed. Besides the perturbations of the lens 9 and the optical plate 10, the merit function also contains the dependency of the perturbation contributions of the lens 9 on its rotation about the optical axis.

The merit function is subsequently optimised by varying of the degrees of freedom in movement of the mobile parts of the projection lens 6. In the embodiment according to Figure 1, the merit function is evaluated at each rotation position of the rotatable part 7 of the projection lens 6. The rotation position in which the merit function has the optimum value is subsequently determined.

Finally, the mobile optical elements are brought into the target position which has been determined.

In the embodiment according to Figure 1, the rotatable part 7 with the lens 9 is rotated into the target position which has been determined.--

Please delete the Section entitled "ABSTRACT," and replace it with:

-- A method for improving imaging properties of two or more optical elements comprises the step of determining for at least one of the two optical elements a polarisation polarization-dependent perturbation. In a further step a polarisation polarization-independent perturbation is determined for at least one of the two optical elements. Then a target position for the at least one movable optical element is calculated such that, in the target position, the total perturbation of the at least two optical elements which is made up of the polarisation polarization dependent perturbations and polarisation polarization independent perturbations of the two optical elements, is minimized. Finally the at least one movable optical element is moved the to the calculated target position. - -